

MITSUBISHI TRANSISTOR MODULES

QM30DY-H

MEDIUM POWER SWITCHING USE

INSULATED TYPE

QM30DY-H



- **I_c** Collector current **30A**
- **V_{CEx}** Collector-emitter voltage **600V**
- **h_{FE}** DC current gain **75**
- **Insulated Type**
- **UL Recognized**

Yellow Card No. E80276 (N)

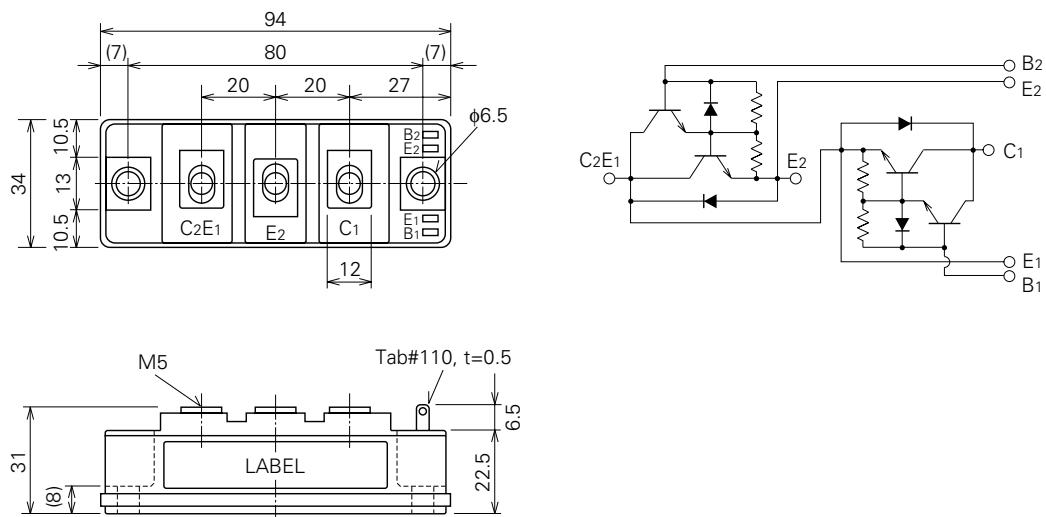
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APPLICATION

AC motor controllers, UPS, CVCF, DC motor controllers, NC equipment, Welders

OUTLINE DRAWING & CIRCUIT DIAGRAM

Dimensions in mm



Feb.1999

ABSOLUTE MAXIMUM RATINGS (T_j=25°C, unless otherwise noted)

Symbol	Parameter	Conditions	Ratings	Unit
VCEX (SUS)	Collector-emitter voltage	I _c =1A, V _{EB} =2V	600	V
VCEX	Collector-emitter voltage	V _{EB} =2V	600	V
VCBO	Collector-base voltage	Emitter open	600	V
VEBO	Emitter-base voltage	Collector open	7	V
I _c	Collector current	DC	30	A
-I _c	Collector reverse current	DC (forward diode current)	30	A
P _c	Collector dissipation	T _c =25°C	250	W
I _B	Base current	DC	1.8	A
-I _{CSCM}	Surge collector reverse current (forward diode current)	Peak value of one cycle of 60Hz (half wave)	300	A
T _j	Junction temperature		-40~+150	°C
T _{stg}	Storage temperature		-40~+125	°C
V _{iso}	Isolation voltage	Charged part to case, AC for 1 minute	2500	V
—	Mounting torque	Main terminal screw M5	1.47~1.96	N·m
			15~20	kg·cm
		Mounting screw M6	1.96~2.94	N·m
			20~30	kg·cm
—	Weight	Typical value	210	g

ELECTRICAL CHARACTERISTICS (T_j=25°C, unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
I _{CEX}	Collector cutoff current	V _{CE} =600V, V _{EB} =2V	—	—	1.0	mA
I _{CBO}	Collector cutoff current	V _{CB} =600V, Emitter open	—	—	1.0	mA
I _{EBO}	Emitter cutoff current	V _{EB} =7V	—	—	200	mA
V _{CE} (sat)	Collector-emitter saturation voltage	I _c =30A, I _B =0.4A	—	—	2.0	V
V _{BE} (sat)	Base-emitter saturation voltage		—	—	2.5	V
-V _{CEO}	Collector-emitter reverse voltage	-I _c =30A (diode forward voltage)	—	—	1.85	V
h _{FE}	DC current gain	I _c =30A, V _{CE} =2V/5V	75/100	—	—	—
t _{on}	Switching time	V _{CC} =600V, I _c =30A, I _{B1} =-I _{B2} =0.6A	—	—	1.5	μs
t _s			—	—	12	μs
t _f			—	—	3.0	μs
R _{th (j-c) Q}	Thermal resistance (junction to case)	Transistor part (per 1/2 module)	—	—	0.5	°C/W
R _{th (j-c) R}		Diode part (per 1/2 module)	—	—	2.0	°C/W
R _{th (c-f)}	Contact thermal resistance (case to fin)	Conductive grease applied (per 1/2 module)	—	—	0.15	°C/W